Applicants: Andrew Harvey Barr et al.

Serial No.: 10/621,925 Filed: July 17, 2003

Docket No.: 200308576-1 (H300.213.101)

Title: ALTERNATING VOIDED AREAS OF ANTI-PADS

IN THE CLAIMS

- 1. (Previously Presented) A printed circuit board comprising:
 - a first conductive plane;
 - a second conductive plane substantially parallel to the first conductive plane;
 - a via signal barrel transecting the first and second conductive planes;
- a first anti-pad positioned between the first conductive plane and the via signal barrel, the first anti-pad having a first voided area and a first non-voided area; and
- a second anti-pad positioned between the second conductive plane and the via signal barrel, the second anti-pad having a second voided area and a second non-voided area; wherein the first voided area does not completely overlap the second voided area.
- 2. (Original) The printed circuit board of claim 1, wherein the first conductive plane comprises one of a power plane and a ground plane.
- 3. (Original) The printed circuit board of claim 1, wherein the second conductive plane comprises one of a power plane and a ground plane.
- 4. (Original) The printed circuit board of claim 1, wherein the first and second anti-pads are longer in a first direction than in a second direction.
- 5. (Original) The printed circuit board of claim 1, wherein the first and second anti-pads are partially voided anti-pads.
- 6. (Original) The printed circuit board of claim 1, wherein the first and second anti-pads are configured to maintain board planarity.
- 7. (Original) The printed circuit board of claim 1, wherein the first and second anti-pads are configured for signals through the via signal barrel greater than approximately 2 GHz.

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8. (Original) A printed circuit board comprising:

a first conductive plane;

- a second conductive plane substantially parallel to the first conductive plane;
- a via signal barrel transecting the first and second conductive planes;
- a first partially voided anti-pad positioned between the first conductive plane and the via signal barrel, the first partially voided anti-pad having a first pattern and a first orientation; and

a second partially voided anti-pad positioned between the second conductive plane and the via signal barrel, the second partially voided anti-pad having a second pattern and a second orientation;

wherein the first orientation is offset from the second orientation.

- 9. (Original) The printed circuit board of claim 8, wherein the first and second partially voided anti-pads are configured to maintain planarity of the printed circuit board.
- 10. (Original) The printed circuit board of claim 8, wherein the first and second patterns are substantially identical.
- 11. (Original) The printed circuit board of claim 8, wherein the first and second partially voided anti-pads are configured for signals through the via signal barrel greater than approximately 2 GHz.
- 12. (Original) The printed circuit board of claim 8, wherein the first pattern comprises one of a symmetric pattern and an asymmetric pattern.
- 13. (Original) The printed circuit board of claim 8, wherein the first pattern comprises one of a concentric circles pattern, a radial spokes pattern, and an arbitrary pattern.
- 14. (Original) The printed circuit board of claim 8, wherein the first pattern comprises a screen pattern.

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15. (Original) A printed circuit board comprising:

a first conductive plane;

- a second conductive plane substantially parallel to the first conductive plane;
- a first via signal barrel transecting the first and second conductive planes;
- a first anti-pad positioned between the first conductive plane and the first via signal barrel, the first anti-pad having a first length and a first width and a first orientation; and
- a second anti-pad positioned between the second conductive plane and the first via signal barrel, the second anti-pad having a second length and a second width and a second orientation;

wherein the first orientation is offset from the second orientation.

- 16. (Original) The printed circuit board of claim 15, wherein the first length and the first width are not equal.
- 17. (Original) The printed circuit board of claim 15, wherein the second length and the second width are not equal.
- 18. (Original) The printed circuit board of claim 15, wherein the first and second anti-pads are configured to maintain planarity of the printed circuit board.
- 19. (Original) The printed circuit board of claim 15, wherein the first and second anti-pads are configured for signals through the first via signal barrel greater than approximately 2 GHz.
- 20. (Original) The printed circuit board of claim 15, wherein the first length substantially equals the second length and the first width equals the second width.
- 21. (Original) The printed circuit board of claim 15, wherein the first and second anti-pads are substantially oval shaped.

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22. (Original) The printed circuit board of claim 15, wherein the first orientation is substantially perpendicular to the second orientation.

23. (Original) The printed circuit board of claim 15, further comprising:

a second via signal barrel parallel to the first via signal barrel and transecting the first and second conductive planes;

a third anti-pad positioned between the second via signal barrel and the first conductive plane, the third anti-pad having a third orientation; and

a fourth anti-pad positioned between the second via signal barrel and the second conductive plane, the fourth anti-pad having a fourth orientation;

wherein the first and third orientations are substantially identical and adapted to allow a signal trace between the first and third anti-pads on an adjacent signal plane.

24. (Original) A method for forming a printed circuit board, comprising:

providing a first conductive plane;

providing a second conductive plane substantially parallel to the first conductive plane;

forming a via signal barrel transecting the first and second conductive planes; forming a first anti-pad positioned between the first conductive plane and the via signal barrel, such that the first anti-pad has a first orientation and a first void; and

forming a second anti-pad positioned between the second conductive plane and the via signal barrel, such that the second anti-pad has a second orientation and a second void; wherein the first orientation is offset from the second orientation; and wherein the first void does not completely overlap the second void.

- 25. (Original) The method of claim 24, wherein the first and second anti-pads are configured to maintain planarity of the printed circuit board.
- 26. (Original) The method of claim 24, wherein the first and second anti-pads are substantially oval shaped.

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- 27. (Original) The method of claim 24, wherein the first and second anti-pads are partially voided in a pattern.
- 28. (Original) The method of claim 27, wherein the pattern comprises one of a symmetric pattern and an asymmetric pattern.
- 29. (Original) The method of claim 27, wherein the pattern comprises one of a concentric circles pattern, a radial spokes pattern, and an arbitrary pattern.
- 30. (Original) The method of claim 27, wherein the pattern comprises a screen pattern.
- 31. (Original) The method of claim 24, wherein the first and second anti-pads are configured for signals through the via signal barrel greater than approximately 2 GHz.